

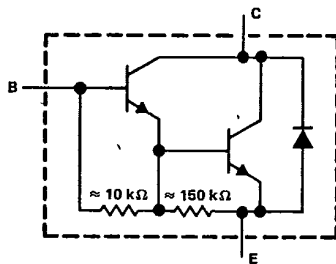
8961726 TEXAS INSTR (OPTO)

62C 36882 D

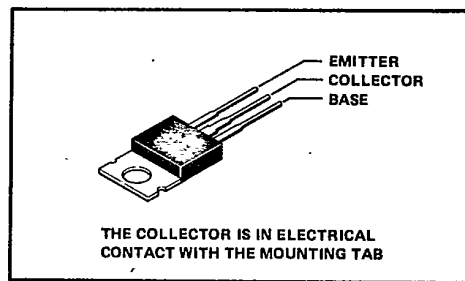
**TIP110, TIP111, TIP112**  
**N-P-N DARLINGTON-CONNECTED**  
**SILICON POWER TRANSISTORS**  
 REVISED OCTOBER 1984

- Designed for Complementary Use With TIP115, TIP116, TIP117 T-33-29
- High SOA Capability, 40 V and 1.25 A
- 50 W at 25°C Case Temperature
- 4 A Rated Collector Current
- Min  $h_{FE}$  of 500 at 4 V, 2 A
- 25 mJ Reverse Energy Rating

device schematic



TO-220 PACKAGE



absolute maximum ratings at 25°C case temperature (unless otherwise noted)

	TIP110	TIP111	TIP112
Collector-base voltage	60 V	80 V	100 V
Collector-emitter voltage ( $I_B = 0$ )	60 V	80 V	100 V
Emitter-base voltage	5 V		
Continuous collector current	4 A		
Peak collector current (see Note 1)	6 A		
Continuous base current	50 mA		
Safe operating area at (or below) 25°C case temperature	See Figures 7 and 8		
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)	50 W		
Continuous device dissipation at (or below) 25°C free-air temperature (see Note 3)	2 W		
Unclamped inductive load energy (see Note 4)	25 mJ		
Operating collector junction and storage temperature range	-65°C to 150°C		
Lead temperature 3,2 mm (0.125 inch) from case for 10 seconds	260°C		

- NOTES:
1. This value applies for  $t_w \leq 0.3$  ms, duty cycle  $\leq 10\%$ .
  2. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C or refer to Dissipation Derating Curve, Figure 9.
  3. Derate linearly to 150°C free-air temperature at the rate of 16 mW/°C or refer to Dissipation Derating Curve, Figure 10.
  4. This rating is based on the capability of the transistors to operate safely in the circuit of Figure 2.  $L = 20$  mH,  $R_{BB2} = 100 \Omega$ ,  $V_{BB2} = 0$  V,  $R_S = 0.1 \Omega$ ,  $V_{CC} = 20$  V, Energy  $\approx I_C^2 L/2$ .

5 TIP Devices

8961726 TEXAS INSTR (OPTO)

62C 36883 D

T-33-29

**TIP110, TIP111, TIP112  
N-P-N DARLINGTON-CONNECTED  
SILICON POWER TRANSISTORS**

**electrical characteristics at 25°C case temperature**

PARAMETER	TEST CONDITIONS	TIP110		TIP111		TIP112		UNIT			
		MIN	TYP	MAX	MIN	TYP	MAX		MIN	TYP	MAX
$V_{(BR)CEO}$	$I_C = 30 \text{ mA}$ , See Note 5 $I_B = 0$	60			80			100			V
$I_{CEO}$	$V_{CE} = 30 \text{ V}$ , $I_B = 0$		2								mA
	$V_{CE} = 40 \text{ V}$ , $I_B = 0$				2						
	$V_{CE} = 50 \text{ V}$ , $I_B = 0$						2				
$I_{CBO}$	$V_{CB} = 60 \text{ V}$ , $I_E = 0$		1								mA
	$V_{CB} = 80 \text{ V}$ , $I_E = 0$				1						
	$V_{CB} = 100 \text{ V}$ , $I_E = 0$						1				
$I_{EBO}$	$V_{EB} = 5 \text{ V}$ , $I_C = 0$		2		2			2			mA
$h_{FE}$	$V_{CE} = 4 \text{ V}$ , See Notes 5 and 6 $I_C = 1 \text{ A}$	1000			1000			1000			
	$V_{CE} = 4 \text{ V}$ , See Notes 5 and 6 $I_C = 2 \text{ A}$	500			500			500			
$V_{BE}$	$V_{CE} = 4 \text{ V}$ , See Notes 5 and 6 $I_C = 2 \text{ A}$		2.8		2.8			2.8			V
$V_{CE(sat)}$	$I_B = 8 \text{ mA}$ , See Notes 5 and 6 $I_C = 2 \text{ A}$		2.5		2.5			2.5			V
$V_F$	$I_F = I_C = 4 \text{ A}$ , See Notes 5 and 6		3.5		3.5			3.5			V

- NOTES: 5. These parameters must be measured using pulse techniques,  $t_w = 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .  
6. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 3.2mm (0.125 inch) from the device body.

**resistive-load switching characteristics at 25°C case temperature**

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
$t_{on}$	$I_C = 2 \text{ A}$ , $I_{B1} = 8 \text{ mA}$ , $I_{B2} = -8 \text{ mA}$ , $V_{BE(off)} = -5 \text{ V}$ , $R_L = 15 \Omega$ , See Figure 1		2.6		$\mu\text{s}$
$t_{off}$			4.5		

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.



TIP Devices

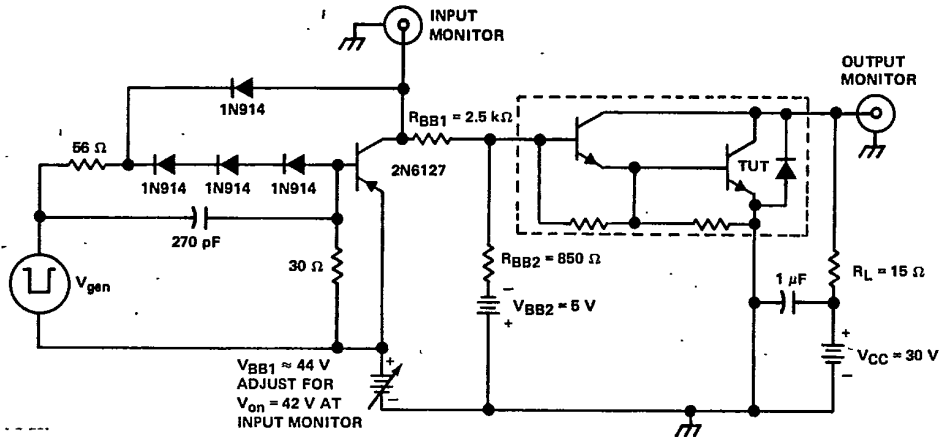
8961726 TEXAS INSTR (OPTO)

62C 36884 D

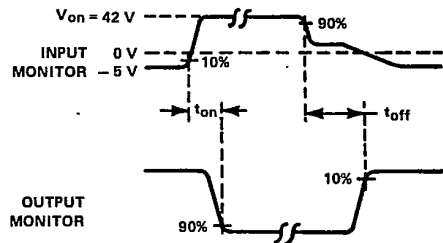
TIP110, TIP111, TIP112  
N-P-N DARLINGTON-CONNECTED  
SILICON POWER TRANSISTORS

PARAMETER MEASUREMENT INFORMATION

T-33-29



TEST CIRCUIT



VOLTAGE WAVEFORMS

- NOTES:
- A.  $V_{gen}$  is a  $-30\text{V}$  pulse into a  $50\ \Omega$  termination.
  - B. The  $V_{gen}$  waveform is supplied by a generator with the following characteristics:  $t_r \leq 15\text{ ns}$ ,  $t_f \leq 15\text{ ns}$ ,  $Z_{out} = 50\ \Omega$ ,  $t_w = 20\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .
  - C. Waveforms are monitored on an oscilloscope with the following characteristics:  $t_r \leq 15\text{ ns}$ ,  $R_{in} \geq 10\text{ M}\Omega$ ,  $C_{in} \leq 11.5\text{ pF}$ .
  - D. Resistors must be noninductive types.
  - E. The d-c power supplies may require additional bypassing in order to minimize ringing.

FIGURE 1. RESISTIVE-LOAD SWITCHING

5  
TIP Devices

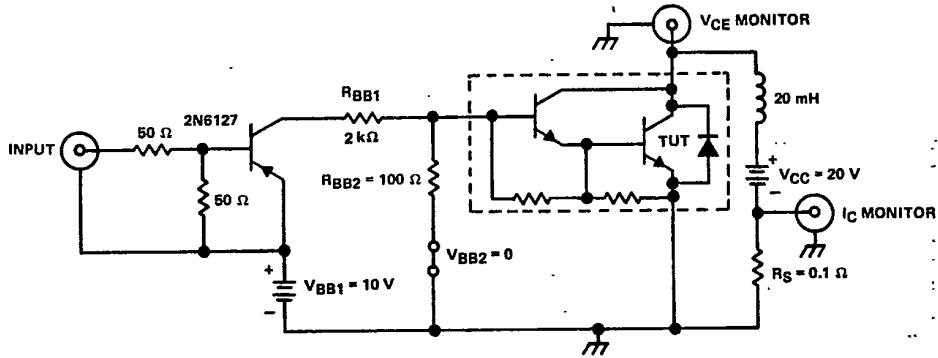
8961726 TEXAS INSTR (OPTO)

62C 36885 D

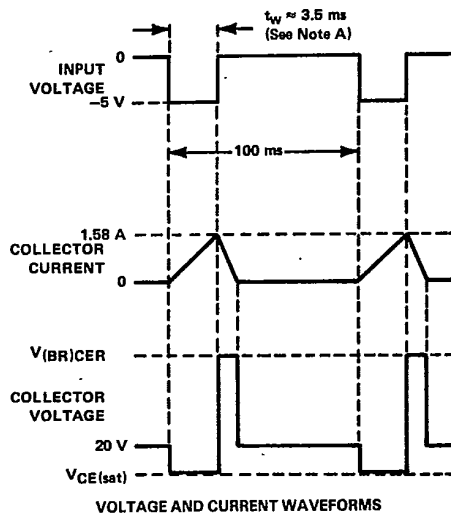
T-33-29

TIP110, TIP111, TIP112  
N-P-N DARLINGTON-CONNECTED  
SILICON POWER TRANSISTORS

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



NOTE A: Input pulse duration is increased until  $I_{CM} = 1.58$  A.

FIGURE 2. INDUCTIVE-LOAD SWITCHING



TIP Devices

8961726 TEXAS INSTR (OPTO)

62C 36886 D

TIP110, TIP111, TIP112  
N-P-N DARLINGTON-CONNECTED  
SILICON POWER TRANSISTORS

TYPICAL CHARACTERISTICS

T-33-29

STATIC FORWARD CURRENT TRANSFER RATIO  
vs  
COLLECTOR CURRENT

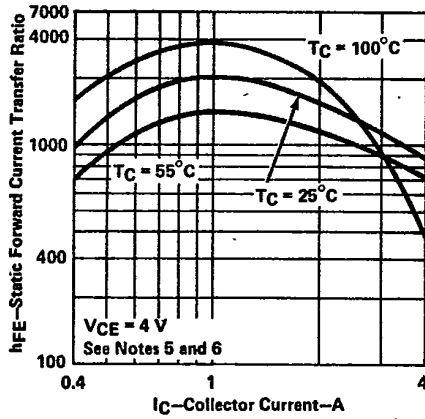


FIGURE 3

BASE-EMITTER VOLTAGE  
vs  
CASE TEMPERATURE

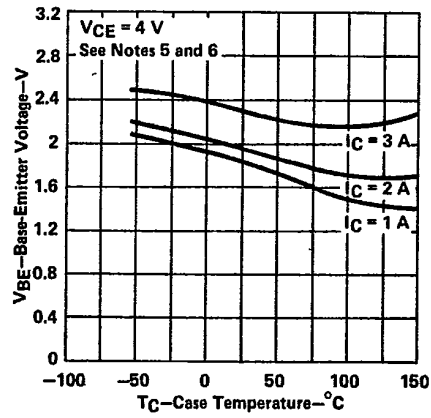


FIGURE 4

COLLECTOR-EMITTER SATURATION VOLTAGE  
vs  
CASE TEMPERATURE

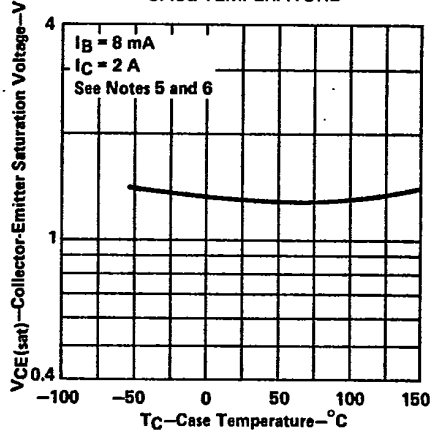


FIGURE 5

SMALL-SIGNAL COMMON-EMITTER  
FORWARD CURRENT TRANSFER RATIO  
vs  
FREQUENCY

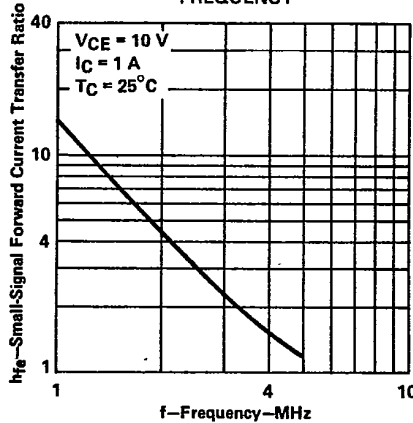


FIGURE 6

- NOTES: 5. These parameters must be measured using pulse techniques,  $t_w = 300 \mu s$ , duty cycle  $\leq 2\%$ .  
6. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 3,2mm (0.125 inch) from the device body.

5  
TIP Devices

8961726 TEXAS INSTR (OPTO)

62C 36887 D

TIP110, TIP111, TIP112  
N-P-N DARLINGTON-CONNECTED  
SILICON POWER TRANSISTORS

T-33-29

MAXIMUM SAFE OPERATING AREA

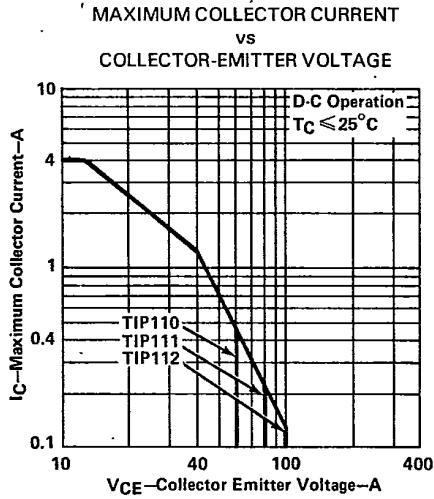


FIGURE 7

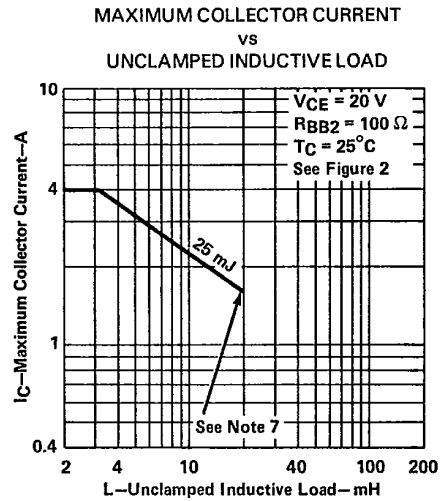


FIGURE 8

NOTE 7: Above this point the safe operating area has not been defined.

THERMAL INFORMATION

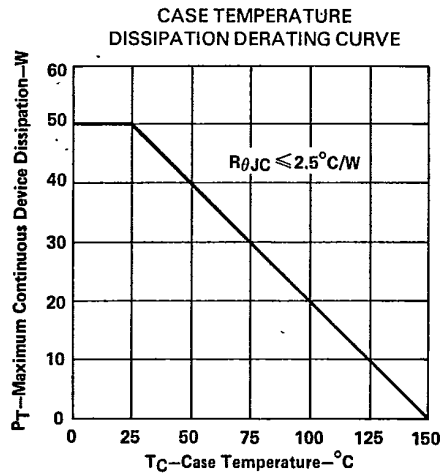


FIGURE 9

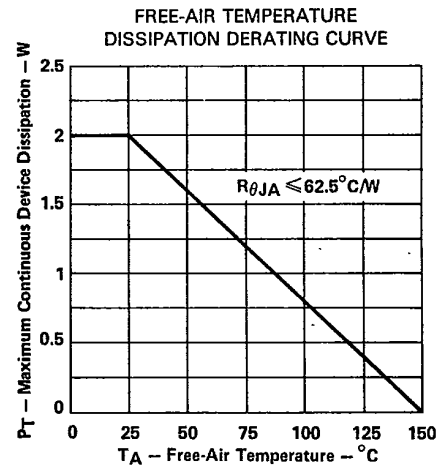


FIGURE 10



TIP Devices